MGV2520101R0M-10

PHYSICAL DIMENSIONS:

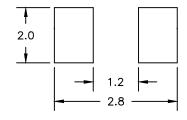
A 2.50 ± 0.20

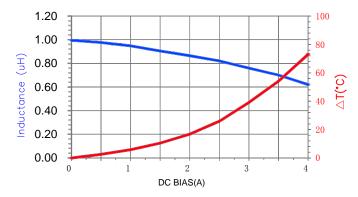
 $B 2.00 \pm 0.20$

C 1.00 Max.

 $D = 0.60 \pm 0.30$

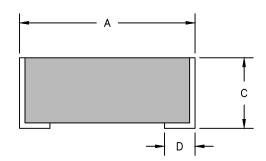
LAND PATTERNS FOR REFLOW SOLDERING



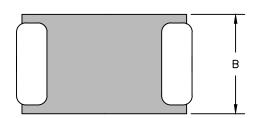


ELECTRICAL SPECIFICATION @ 25°C

	Min	Norm	Max
INDUCTANCE (uH) L @ 1MHz/1mA ±20%	0.80	1.00	1.20
DCR (Ω)		0.045	0.054
Saturation Current Isat (A)		3.50	3.15
Heating Current Irms (A)		3.00	2.70







NOTES:

- 1. OPERATING TEMPERATURE RANGE: -40° C $\sim +125^{\circ}$ C.
- 2. STORAGE TEMPERATURE RANGE: -40° C $\sim +125^{\circ}$ C.
- 3. Isat MEANS THAT MAX DC CURRENT WILL CAUSE APPROXIMATELY 30% INDUCTANCE REDUCTION FROM INITIAL VALUE.
- 4. Irms MEANS THAT MAX DC CURRENT WILL CAUSE COIL TEMPERATURE RISE APPROXIMATELY 40°C AT AMBIENT 25±5°C.

	DIMENSIONS ARE IN mm.			This print is the property of Lair. Tech. and is loaned in confidence subject to return upon request a with the understanding that no copies shall be made without the written consent of Laird Tech. All rights to design or invention are reserved.	e ind	Laird		
				PROJECT/PART NUMBER:	REV	PART TO		DRAWN BY:
				MGV2520101R0M-10			OKE ICTOR	QIU
				F 09 /20 /1 /	CALE:	NTS	SHEET:	
Α	NEW RELEASE	09/20/17	QIU	, ,	OOL #	1113		
REV	DESCRIPTION	DATE	INT	MGV2520101R0M-10-A	F	-	1	of 1